

Herald

Service Manual



HTC Proprietary Confidential Treatment Requested

Rev. A01

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HTC Corp.

Engineering Mobility



Revision Control Table

| Rev | Date | Contents | Dept. | Revised | App Dept | Stage/Per |
|------|------------|---|-------|--------------|----------|-----------|
| AX01 | 2006/10/16 | First Draft | PSE | Jerry W. Lin | GSD | DVT |
| AX02 | 2006/11/16 | Add Procedure | PSE | Jerry W. Lin | GSD | PVT |
| AX03 | 2006/11/17 | Add description | PSE | Jerry W. Lin | GSD | PVT |
| A01 | 2006/11/24 | Add L2.5, update keyboard upper cover combine description | PSE | Jerry W. Lin | GSD | MV |
| | | | | | | |
| | | | | | | |



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CHAPTER 1 – INTRODUCTION

1.1 Product Specification

| Item | Specification | |
|---------------------|---|--|
| Soldering status | Meet Lead-free requirement | |
| Platform | Microsoft Windows Pocket PC phone edition | |
| | Thin and Elegant PPC phone with integrated | |
| | quad-band GSM/EDGE, Bluetooth, WiFi, 2.0 | |
| | mega-pixel camera, sliding QWERTY keyboard | |
| Dimensions | • 59mm(W) x 109mm(H) x 17mm (T) | |
| Weight | Less than 168 g (Main unit with battery pack) | |
| Processor/Chipset | TI OMAP 850 + TI E-Syren | |
| Memory | ROM: 128/256MB (for programs and users' storage) | |
| | RAM: 64 MB DDR SDRAM | |
| LCD Module | 65K-color TFT LCD with white LED back light | |
| | 2.8" 240 x 320 dots resolution | |
| | Sensitive Touch Screen | |
| GPRS/GSM (Tri-band) | Internal Antenna | |
| module | Quad-Band (850/900/1800/1900)MHz | |
| | Audio codec: AMR, EFR, FR, HR | |
| | Supplement services | |
| | * Call holding/waiting/forwarding | |
| | * Call barring | |
| | * CLI (Call line Identity) | |
| | * SMS (Short Message Service) | |
| | * Display own number | |
| | * Network selection(3GPP T2 23.122 V3.6.0) | |
| | * Cell broadcast | |
| | * Multi-party conference call | |
| | * Spool Icon | |
| | * Network lock | |



| EDGE functionality | EGPRS Class B, |
|------------------------|--|
| , , | Multi-slot Class 10 |
| | PBCCH |
| | PPP over GPRS |
| SIM | 1.8V/3 V SIM Operation |
| | SIM Application Tool Kit release 98 class 3 |
| | Over the Air (OTA) provisioning |
| | • FDN/AND/SDN |
| | Support SIM+ |
| Stylus | Lock type mechanism |
| Keyboard/Button/Switch | Power button (on top) |
| | Comm. Manager (right side button) |
| | Voice dial/Voice recorder button (right side button) |
| | Camera capture (left side button) |
| | Sliding Volume Up/Down(left side switch) |
| | 2 soft keys (left and right) |
| | Five way navigation pad |
| | 2 phone button, Send & End |
| | 2 AP buttons, Start & OK |
| | Reset Switch |
| | Sliding QWERTY keyboard + 2 soft keys |
| Interface | 1.8V/3V SIM card |
| | Micro-SD card slot |
| | External RF connector with cover |
| | • 11 pins HTC specific mini-USB (Slave USB, Power IN, |
| | Audio) |
| Notification | One Bi-color LED for GSM standby, GSM message, |
| | GSM network status, notification, and charging status. |
| | Two respective (blue and green) LEDs for for |
| | Bluetooth/ WiFi notification. |
| | Vibration for notificaiton |
| | Notification by sound, message on the display. |



| CMOS Camera | CMOS 2.0 mega Pixel |
|-------------|--|
| | Preview Mirror effect |
| Audio | Build-in Microphone |
| | Receiver |
| | Loud speaker for Hands-free supported |
| | WAV/WMA/AMR/AAC/MP3 codec. |
| | • 16 bits with 8KHz,11 KHz, 22KHz,44.1 KHz, |
| | sampling rate |
| | Audio Path Routing for VoIP over WLAN |
| | Audio Echo Cancellation for VoIP over WLAN |
| Bluetooth | Compliant with V2.0 without EDR |
| | Class 2 transmit power |
| | Supported profiles: |
| | Serial Port profile |
| | Object Push profile |
| | DUN profile |
| | Generic Object Exchange profile |
| | Headset profile |
| | Heads-free profile |
| | ➤ A2DP |
| | Audio/Video Remote Control profile |
| | Human Interface Device profile |
| | Service Discovery Application profile |
| | SIM Access profile |
| | File Transfer profile |
| | Co-exist with WiFi |
| WiFi | IEEE 802.11b/g compliant |
| | Internal WLAN Antenna |
| | Data rate auto fallback for extended range |
| | ELP mode |
| | Security |
| | * WPA authentication |
| | • QoS |
| | *Fast AP to AP handover (currently support Cisco AP) |



| Dettem | Democrable machanischle Liftbirde Debussen beiter |
|-------------|---|
| Battery | Removable rechargeable Lithium Polymer battery |
| | • 1130 mAH |
| | Battery Life: |
| | * WMA: 12 hours |
| | * WMV: 8 hours |
| | Talk time: 3.5 ~ 5 hrs |
| | Standby Time: 150 ~ 200 hrs |
| AC Adapter | AC input 100 ~ 240 V AC, 50/60 HZ |
| | DC output : 5V / 1A |
| Regulatory | GCF certification |
| | R&TTE: EMC/EMI, CEM, Safety SAR |
| | WiFi Certification |
| | • FCC |
| | • PTCRB |
| | Bluetooth Qualification Body Certification |
| | Microsoft Windows Mobile logo (NTSL) |
| | USB Certification |
| Accessories | Carrying Case |
| | AC adapter with mini-USB plug |
| | Sync. Cable (mini-USB) |
| | Battery (rechargeable and replaceable) |
| | Stereo wired headset with microphone |
| | User Manual, quick start guide, sync. Software CD |
| | Car adapter |
| | Car holder |
| | Wrist Strap |
| | Cradle (optional) |
| | Car Kit (optional) |
| | Water resistant cover (optional) |
| | • Water resistant cover (optional) |
| | |



CHAPTER 2 - TOOLS

2.1 Repair Level Definition

Unit

LO Accessory test and unit swap

L1 Unit Test and ROM Re-flash

L2 Refurbishment and Module Swap +L1

L2.5 M/B Repair(connecter, button, MIC...) +L2

Note: These level is for reference only depends on service model

2.2 List of Servicing Tools

| level | No. | Item | Use for | Remark |
|-------|-----|-------------------------------|---------------------------------|----------------|
| | 1 | Mini USB DATA interface | Check for mini USB | |
| | | Cable | communication; RUU re-flash | |
| | 2 | Earphone Headset | For Audio test. | |
| | 3 | AC Adapter | Transfer AC to DC for Unit | |
| | 4 | WLAN AP | For WiFi test | |
| | 5 | Micro SD Card with | For unit diagnostic test | HTC design |
| | | Diagnostic test program (must | | |
| L 1 | | be encoded by HTC) | | |
| LI | 6 | 128MB micro SD memory | For unit ROM code transfer to | HTC design |
| | | card (must be encoded by | SD card for re-flash | |
| | | HTC) | | |
| | 7 | Unit current consumption test | | HTC design |
| | | fixture | Measure Unit current | |
| | 8 | Power supply | consumption | Local purchase |
| | 9 | Current Meter | | Local purchase |
| | 10 | Mobile tester | For RF test | Local purchase |
| | 11 | Special Made Plastic Stick | Assembly & Disassembly | HTC special |
| | | | | tools |
| L 2 | 12 | Hand tools | Assembly & Disassembly | Local purchase |
| | 13 | Label printer | Print agency label if replacing | Local purchase |
| | | | M/B | |
| 125 | 14 | Lead-free Soldering station | Board level repair | Local purchase |
| L 2.5 | 15 | Air heater | Board level repair | Local purchase |

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CHAPTER 3 – DISASSEMBLING AND ASSEMBLING

3.1 Disassembling



Tools needed for Assembling and Disassembling

- 1. Glove & Lens Cleaning Tissue.
- 2. Plastic type tweezers.
- 3. Philip Screw Driver 000X40.
- 4. Philip Screw Driver T6X40
- 5. Flat Plastic Stick



Main Unit



- 1. Eject the Stylus.
- 2. Eject the micro SD card if available.





Release rear cover lock by pressing to right



Release battery



Unfasten 4 screws located on rear of unit







Release the antenna & speaker module





Disassembly C & D parts.

Carefully insert flat plastic stick into the gap between C & D part. Be noticed this action should be performed very carefully.



Using the flat stick and move along the gap of the unit.



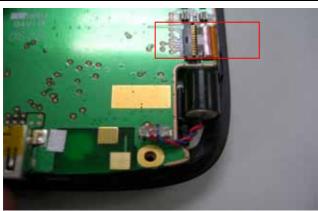


Release the housing



Unfasten one screw which fix the MB

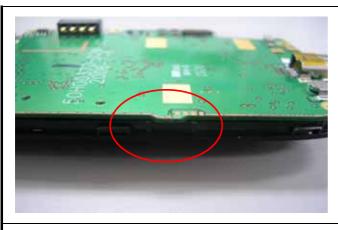




Disassemble vibrator, and release keyboard FPC



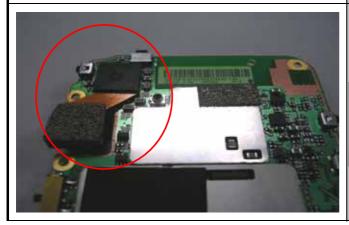




Release board from its hook



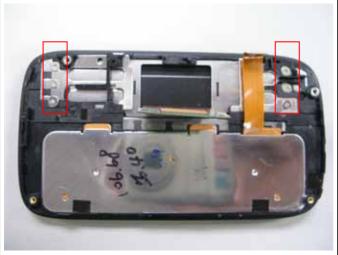
Lift up the main board, release the LCM FPC and take out the MB



Release Camera from its connector







Unfasten 6 screws located on C & D part (rear housing)





Release keyboard



Unfasten 4 screws as shown on picture





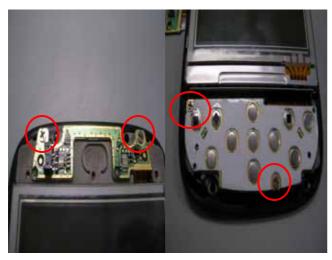


Upper part dis-assembly



Release receiver





Unfasten two screws of RF board and two located on metal dome







Release LCM FPC, separate RF board from LCM



Release keypad from Bezel





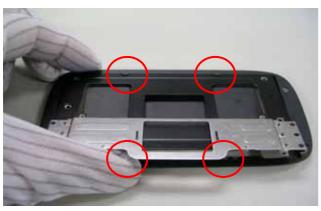
Disassemble display bottom COVER



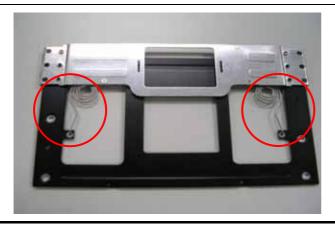


Unfasten the screws





Remove slider from bottom cover





Remove slider from its hinge

----- Disassembly process is done-----



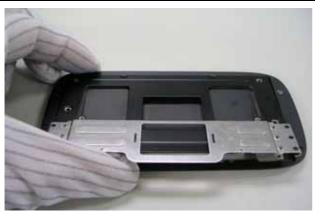
3.2 Assembling



Assemble slider hinge



Align to its position



Put Slider into bottom cover





Assemble slider and fasten 6 screws

72H01701-00M

Torque: 1.1 +0.1 kg-cm



Assemble LCM and connect its FPC into RF board



Put the RF board FPC to pass through slider hole





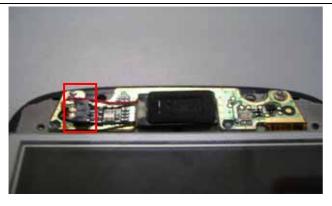
Maker sure FPC through the Slider



Fasten 4 screws of RF board to display bottom cover

72H1715-00M

Torque: 0.8 +- 0.1kg-cm



Assemble receiver, put one tape to fix its wire





Put keypad on it

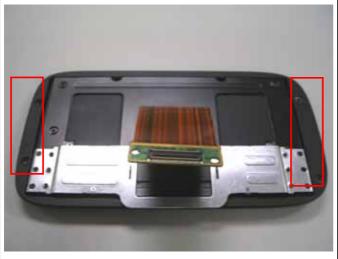


Continue with assemble the bezel,



Starting from left and right then to the top





Fasten 4 screws on display bottom cover

72H01706-00M

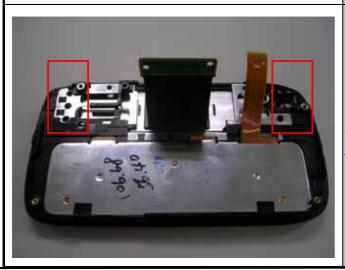
Torque: 0.8 +- 0.1kg-cm



Combine keyboard upper cover with display bezel



keyboard upper cover
(combine with FPC/Keypad Qwerty key)
Need Fixture to assemble



Fasten 6 screws of keyboard upper cover

72H1696-00M

Torque: 0.8 +- 0.1kg-cm

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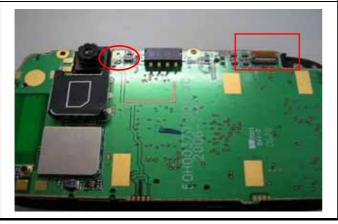




Assemble Camera



Pull out the slider and connect LCM FPC into MB Then stick LCM FPC with adhesive tape, plus one tape to fix LCM FPC



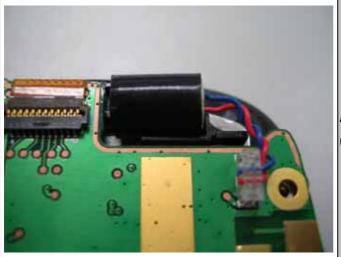
Assemble MB by inserting into ring, put MB into keyboard upper cover and fasten one screw on it.(below camera)

Next, fasten the keypad FPC connector

72H1715-00M

Torque: 0.8 +- 0.1kg-cm





Assemble vibrator into MB and put it in keyboard upper cover.

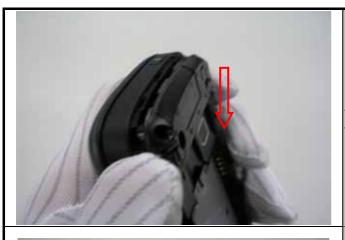


Then assemble MB into housing starting from its USB connector



Check each button is assembly properly into its position





Assemble antenna and speaker module starting from its right lower part



Fasten 4 screws on rear side 72H01691H-00M
Torque 1.2 ± 0.1 kg-cm



Put battery in.





Assemble battery cover and lock it into position



Insert Stylus

----- Assembly process is done-----



CHAPTER 4 – DIAGNOSTIC PROGRAM

4.1 List of Diagnostic / WinCE Test Items

| Mode | No | Item | Description | Remark | |
|------------|---|-----------------------|--|--------|--|
| | Fun | ction Test | | | |
| | 1 | SDRAM Test | RAM memory test. | | |
| | 2 | Display Test | Color bar/R/G/B/ White/Black/ /Gray pattern. | | |
| | 3 | LED Test | Red/Green/ Blue/Key Pad. | | |
| | 4 | Key Test | Capture/Volume up,down/Talk/Soft1/Start/Up/Right | | |
| | | | /Down/Left/Action/Soft2/OK/End/PTT/WLAN/ | | |
| | 5 | B. L Test | Front light test | | |
| | 6 | Timer Test | RTC (Real time clock) test. | | |
| | 7 | SD Card Test | SD card Read/Write test. | | |
| | 8 | Mega SIM Test | Mega SIM card test. | | |
| ပ | 9 | Checksum Test | ROM checksum test. | | |
| sti | 10 | Battery Test | Battery info check. | | |
| Diagnostic | 11 | Vibrator Test | Vibrator on test. | | |
| jaç | 12 | Headset Play Test | Headset out test. | | |
| | 13 | Speaker Play Test | Speaker out test. | | |
| | 14 | Receiver Play Test | Receiver out test. | | |
| | 15 | Int. Rec-Spk out Test | Internal MIC record and play to Speaker test. | | |
| | 16 | Int. Rec-HST out Test | Internal MIC record and play to Headset test. | | |
| | Run-in Test | | | | |
| | 1 | 1 Hour | 1 Hour Run-in Test/Press Soft1 key. | Option | |
| | 2 | 2 Hours | 2 Hours Run-in Test/Press Soft 2 key. | Option | |
| | 3 | 4 Hours | 4 Hours Run-in Test/Press Start key. | Option | |
| | 4 | 8 Hours | 8 Hours Run-in Test/Press OK key. | Option | |
| | Format FAT / Clear PIN (Personal information, talk times) | | | | |
| | Device Info | | | | |
| | 1 | USB Test | USB link test (Microsoft ActiveSync). | | |
| Win CE | 2 | Camera Test | Camera test. | | |
| | 3 | Bluetooth Test | Bluetooth test. | | |

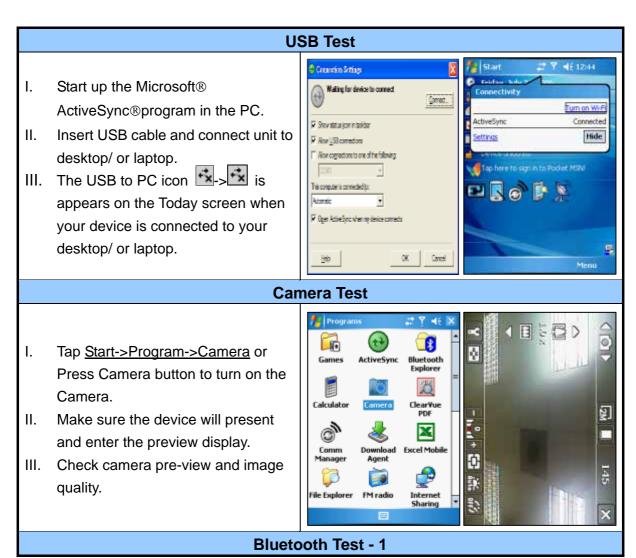


| | 4 | WLAN Test | WLAN test. | |
|--|---|-----------|------------|--|
| | 5 | GPS Test | GPS test. | |

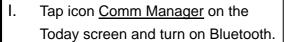
4.2 Test Procedure

How to select test item: Using navigation button -"Up" or "Down" or to select the test items. How to execute the test program: Press "Action" button to start each of test items.

WinCE Test







- II. Tap the icon "Settings" down-right the corner of the screen and select the "Make this device...." Checkbox.
- III. Press Action key (Jog-ball) to go next test pattern.



Bluetooth Test - 2

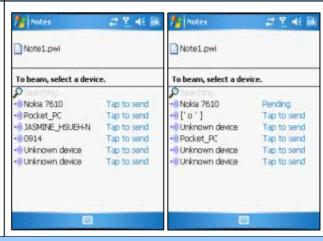
- Tap <u>Start->Settings->Connections-></u>
 <u>Beam</u> and select "Receive all...."

 Checkbox.
- II. To create a file, tap Start->Programs->Notes->New.
- III. Tap and select the "Beam file..."



Bluetooth Test - 3

- IV. Once device is searched, tap the device to send the file.
- V. Return to Today screen and tap <u>Start->Program->Comm Manager</u> <u>->Bluetooth</u> to turn off Bluetooth.



WLAN Test



- Tap icon <u>Comm Manager</u> on the Today screen and turn on WLAN.
- II. Select the hot-spot/ or access point which searchable and appears on screen.
- III. Once the hot-spot (access point) is connected, press the IE button and logon Internet.





CHAPTER 5 – SOFTWARE UPGRADE PRCEDURE

System Requirement:

- -Windows 2000/XP
- -USB Cable
- -ActiveSync 4.0 above
- -Master Unit
- -128 MB Mini SD card

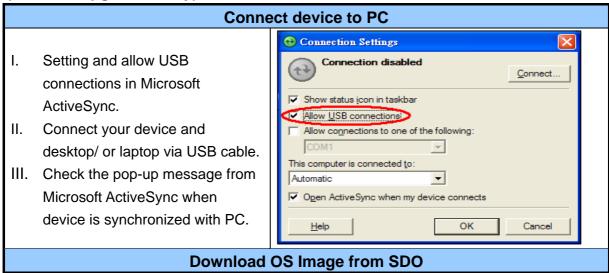
Caution: The unit must have at least 70% of battery capacity before starting the re-flash process. Charge the battery in advance if necessary.

For the master unit, you could prepare it in the following ways:

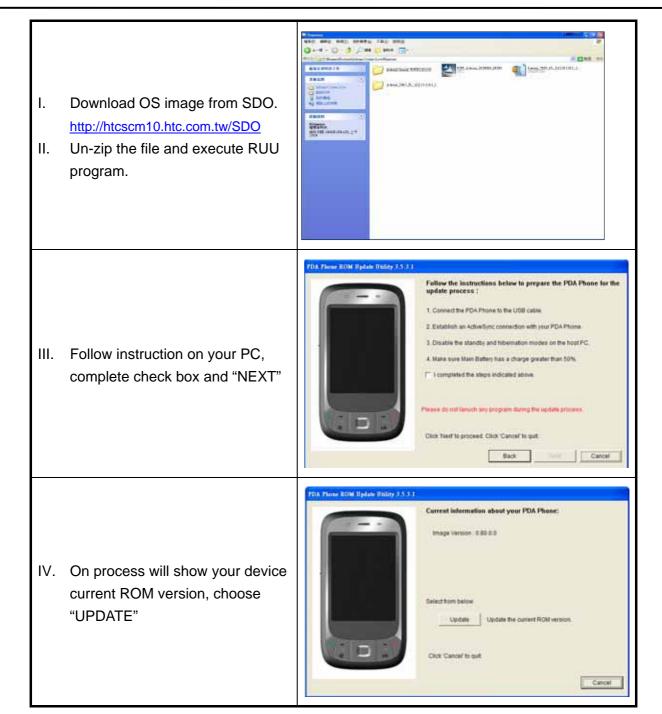
- Take one from Swap unit with the most up to date Rom Code.
- Build one first by connecting to SDO for OS Upgrade/ Download via RUU.

HTC RMAIII - Service Document Online: https://rma.htc.com.tw/rmaiii/home/index.asp

5.1 RUU (Re-flash Upgrade Utility)

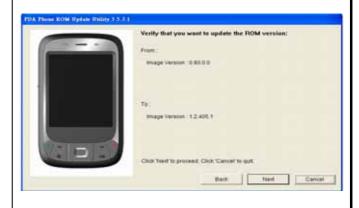








V. Confirm your ROM version and new update version,then choose "NEXT"



VI. Click "Next" to proceed.



VII. Read the information from pop-up message and the OS update procedure will takes 10 minutes long.

Click "Next" to proceed.



VIII. You can see the update progress from your PC and in your device.

Please on our renow the USS connection from the PDA Phone or launch any program during the under process.

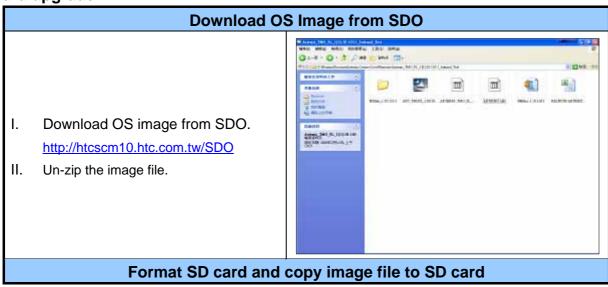
Remember, the operation will take about 10 minutes.

RUU - 7

IX. The OS upgrade is finished, click "Finish" to close the utility.

Congratulation

5.2 SD card upgrade





- III. Select file system and format the SD card to FAT32 mode.
- IV. Copy the image file XXX.nbh to Micro SD card and rename to HERAIMG.NBH.

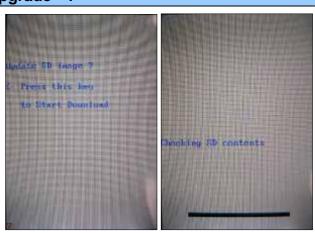


SD Upgrade - 1

- V. Turn the device power off and insert Diagnostic SD card.
- VI. Press and hold <u>Capture + Comm</u>

 <u>MGR</u> button, and <u>Reset</u> button to entry Boot loader mode.
- VII. Press power key to start upgrade procedure.

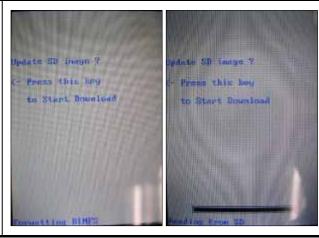
[Note]: This process will takes 5 mins, please don't power off the device.



SD Upgrade - 2

VIII. Take out the SD card.

IX. Cold boot the device.



Now the upgrade is done!

Note: Due to security issue, it is not allowed to re-flash different customer ID.



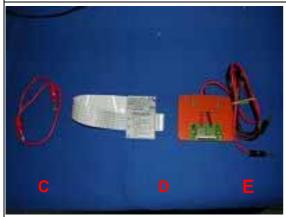
CHAPTER 6 – LEAKAGE CURRENT MEASUREMENT

This is a quick method to measure if any abnormal leakage current on main board which caused high power consumption compare to GOOD main board.

- (1) Requirement:
 - Power Supply
 - Micro-current Meter
 - Current series JIG
 - CABLE
 - Battery JIG

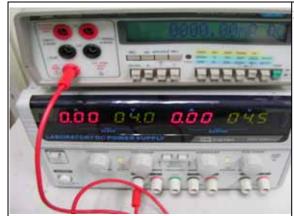


- 1.Equipment need:
- A. Power Supply (set at 4 V /1A).
- B. Micro-Current Meter (support 0.5mA ~ 1A).

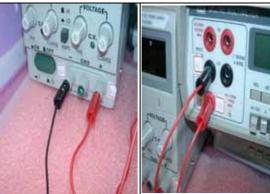


- 2. Fixture needed
- C. Cable
- D. Battery with extension cable
- E. Current series jig.(with black and red cable)



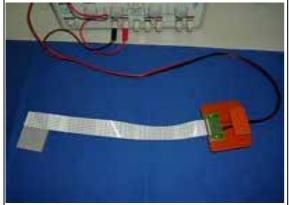


3. Connect cable (C) to positive polarity of power supply(A) and current meter (B)



 Connect cable of fixture(C) to negative polarity of power supply (A) and current meter (B)

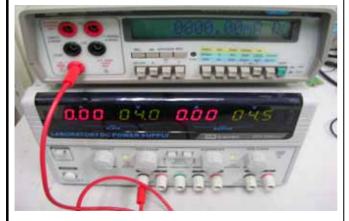
Note: black cable to power supply (A) and red cable to current meter (B)



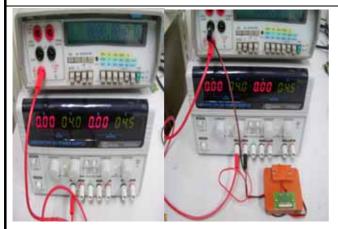
Setting is Ready for testing
 Assemble Battery into device.
 (Don't turn the power on at this moment)

Assemble Battery into device.





3. Connect cable (C) to positive polarity of power supply (A) and current meter (B)

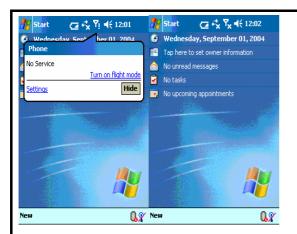


4. Connect cable of fixture(E) to negative polarity of power supply (A) and current meter (B)



5. Setting is Ready now for testing (Don't turn the power on at this moment)





6.Turn on power supply (4V) and current meter (2A)

Set the unit to:

- * Flight mode
- * Turn off Bluetooth



7. Measure flight mode current

Choice

Setting/System/Backlight/Brightness Adjust brightness level to power save. Current value must under **78mA**, if over, it means M/B failed, please replace M/B for repair.



- Switch OFF the unit.Unit is turn off and no display.
- 9. Measure power off current Check current value on the current meter,

Current value must under 4.5 mA, if over, it means M/B failed, please replace M/B for repair.

Conclusion



- I. If current consumption test PASS when UUT in Flight and Sleep mode, it means that the M/B works normal.
- II. If current consumption test FAIL when UUT in Flight or Sleep mode, it means that the M/B works abnormal, please replace M/B and re-test again.



CHAPTER 7 – COSMETIC INSPECTION CRITERIA

- 1.1 This document based on the experience of customer's requirements is designated as HTC internal quality inspection standard of HERALD series products for HTC.
- 1.2 These cosmetic criteria should be applied in QC1, QC2 and CDIT stations. Regarding functional inspection of CDIT, please refer to CDIT SIP.

7.1 Classes definition of inspective area

7.2.1 (Class 1 area):

Class 1 area => The front side of main unit involve all buttons and LED lens except

7.2.2 (Class 2 area):

Class 2 area =>The view of Qwerty keyboard after slid out main unit (involve stylus)

7.2.3 (Class 3 area):

Class 3 area => 4 sides and back views of main unit.

7.2.4 (Class 4 area):

Class 4 area =>Socket of battery, inner side of battery cover and back side of upper part.

*. Figure 1: (Photo of inspection areas)



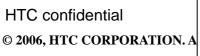
क्रा

Class 1











第 3 區 Class 3





7.2 Main unit inspection

7.3.1 System assembly inspection:

- -Exposure of substratum is not acceptable for peeling. (Area 4 is included)If not exposure of substratum, please checked by SPEC. of dot or scratch. (Area 4 is not included)
- -Logo may not have blurred or double print., the peeling on logo is not acceptable.
- -The character printing of main unit does not allow bad printing, scratch, dirty, lacquer peeling ,dark/white dot on it)
- Camera lens dot, particle D 0.25mm; burr 1.5mm, W 0.2mm,

| 1. | 1. (Gap inspection) | | | | | |
|----|---|--|-------|--|--|--|
| | Description | Accept criteria | | | | |
| 1. | Status of main unit assembly. | Defective assembly and deformed shape were nor allowed. | Minor | | | |
| 2. | Gap between touch panel and bezel. | Gap between touch panel and bezel < 0.7 mm (Skip corner and Enter the material to click) | Minor | | | |
| 3. | Gap between upper / lower slid parts. | Gap between upper / lower slid parts < 10 mm | Minor | | | |
| 4. | Qwerty key Gap and around Gap | Between key Gap<0.35 mm, Edge of key and C-part Gap<0.4 mm | Minor | | | |
| 5. | Gap between navigation key and AP keys assembly. | (gap) <0.35 mm Key stuck are not allowed. | Minor | | | |
| 6. | Gap around power button, record button, volume key, camera button | (gap) <0.35 mm Key stuck are not allowed | Minor | | | |
| 7. | Stylus | Stylus assembly protruding, loose, missing, falling and deformed is not allowed. | Minor | | | |
| 8. | Gap between battery cover and main unit. | D,E parts(gap) <0.50 mm | Minor | | | |



| | | A,B part (gap) <0.3 mm, around stylus (gap) <0.65 | |
|----|---------------------------------|---|-------|
| | Gap between other mating parts. | mm | |
| | | C part (gap) <0.3 mm | |
| 9 | | A,B parts (gap) <0.3 mm, Stylus near key | Minor |
| | | (gap) :0.4mm | |
| | Stylus near key (gap) | Edge of C-part (gap) <0.3 mm | |
| | | B/C-part front and rear GAP Tolerance<0.1mm | |
| 10 | THE PARTS | GAP 0.9mm(Key stuck are not allowed) & APP key hight 0.9mm | Minor |
| | APP KEY around GAP | | |

| 2. (Step inspection) | | | | | |
|--------------------------------|--|------------------|-------|--|--|
| Description Accept criteria Le | | | | | |
| 1. | Step between upper / lower slid parts. | (Step) < 0.50 mm | Minor | | |
| 2. | Others between upper / lower parts. | (Step) < 0.40 mm | Minor | | |

Cosmetic inspection:

| 1. (Scratch) | | | | | | |
|-----------------|--|-------|--|--|--|--|
| Description | Accept criteria | Level | | | | |
| | Class 1/Class 2 /Class 3 | 1 | | | | |
| Class 2/ stylus | Exposure of substratum is not acceptable Scratch: L 7mm,W 0.25mm,N 3, S 10mm Bright mark area should be less than 1 mm x 10 mm | Minor | | | | |
| Class 4 | Any damaged marks, shortage of plating and printing are not acceptable. | Minor | | | | |
| label | Wrong printing or illegible print be not allowed. | Minor | | | | |

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| Description | Accept criteria | Level |
|---------------------------------|--|-------|
| | Class 1/Class 2 /Class 3 | l |
| MS logo Spot | D 0.25mm,N 1 | Minor |
| 3. (Burretc.) | | l |
| Description | Accept criteria | Level |
| Edge damage on all mating parts | L≤3mm, W≤0.254mm | Minor |
| 2. Burr. | W: 0.25mm Max, sharp edge is not acceptable | Minor |
| 4. (Imprint mark) | | |
| Description | Accept criteria | Level |
| Class 1/Class 2 /0 | Class 3 Cosmetic inspection refer to IS-3047 | l |
| 5. (Bright mark) | | |
| | Accept criteria | Level |
| Description | | |
| • | Class 3 Cosmetic inspection refer to IS-3047 | |
| • | Class 3 Cosmetic inspection refer to IS-3047 | |

P.S. Definition of lint identification This definition is not applicable to LCM.



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7.3 Cosmetic of Camera

| Sy | mptom | Standard | Defect model |
|------------|----------------|--------------------------------------|-----------------|
| Glue | Inner glass | Accept | Minor |
| | Out side glass | Over to black area not accept | |
| Line, Lint | Inner glass | W 0.25 mm and L 3.0 mm , N 1 | Minor |
| | | Should not affect to picture quality | |
| | Out side glass | Over to black area not accept | |
| Spot | Inner glass | D 0.25, N 1 | Minor |



CHAPTER 8 -TROUBLESHOOTING AND REPAIR

Before repairing, please try to duplicate if the symptom exist or Customer mishandling

- 1 A . Main Unit Does Not Respond to Power Button
- 1 B . Main Unit Does Not Respond to Battery Switch
- 1 C . Charge light is red when plug in AC adapter
- (1) Make sure the Battery is installed properly to activate the battery pack.
- (2) Connect the AC Adapter, maybe the battery pack is exhaust.
- (3) Check the Battery cover is close properly.
- (4) Try with another battery pack.
- (5) Replace battery pack if necessary.
- (6) Try to enter boot loader mode, Perform Re-flash OS if successfully.
- (7) CMOS Camera is not assembled properly.
- (8) Check all connections including LCD FPC to Main Board. Try with another Main Board.
- (9) Fuse blown.
- (10) Customer abuse caused the power button fallen off
- (11) Both item 9 & 10, MB replacement is necessary unless you are authorized to do board level repair.
- (12) If Charge light is red when plug in AC adapter, it means the main battery is not charge enough and can't power on, You just need to continue charge unit the light become Amber.
- (13) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.

2 - A . Touch Panel Does Not Respond to Screen Tap

- (1) Dismantle the unit, check the perimeter of Display between display Bezel and Touch Panel surface for unusual foreign objects. Clean it, reassemble the unit and check the panel's function again.
- (2) Check the connection of LCM FPC whether is properly connected.
- (3) Try with another LCM.
- (4) Try with another Rigid-Flex board.
- (5) Try with another Main Board.
- (6) Replace LCM if necessary
- (7) Replace Main Board if necessary.
- (8) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.



2 - B . Buttons Do Not Respond

- (1) Dismantle the unit, check the status of switches on the Main Board and the plastic parts of button of the Button not responding.
- (2) Try with another Main Board, rigid-Flex or keypad.
- (3) Replace Main Board, rigid-Flex or keypad if necessary.
- (4) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.
- (5) Hard Reset The unit.

3 - A . Unusual Vertical / Horizontal lines or partial display

- (1) Check the connection of LCM FPC whether is properly connected.
- (2) Try with another LCM.
- (3) Try with another Rigid-Flex board
- (4) Try with another Main Board.
- (5) Replace LCM if necessary
- (6) Replace rigid-Flex board if necessary
- (7) Replace Main Board if necessary.
- (8) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.

3 - B . Back Light Does Not Turn ON/OFF

- (1) Check the connection of FPC whether is properly connected.
- (2) Try with another LCM.
- (3) Try with another Rigid-Flex board
- (4) Try with another Main Board.
- (5) Replace LCM if necessary
- (6) Replace rigid-Flex board if necessary
- (7) Replace Main Board if necessary.
- (8) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.



4 - A-SD Card cannot be used

- (1) Check whether SD is fully inserted to the slot until you hear a click.
- (2) Try with another SD Card
- (3) Try with another Main Board.
- (4) Replace Main Board if necessary.
- (5) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.

5 - A . PC Connection (USB) not possible

- (1) Check whether "Connection Settings" in the MS ActiveSync is properly set.
- (2) Check whether it connects with other cables or cradle, customer's cable might be damaged.
- (3) Check the external appearance of the connector on the unit whether it is physically damaged.
- (4) Replace Main Board if necessary.
- (5) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.

5 - B . Wireless Connection (GSM / GPRS / BT / WLAN) not possible

- (1) Make sure the user has been contacting the Carrier for SIM Card validation and activation.
- (2) Make sure the Wireless Connection Settings has been properly set.
- (3) Make sure the SIM Card is properly inserted to the SIM compartment. Make a life call or test it with the RF Test Station (Antenna Test).
- (4) Dismantle the Main Unit and check whether the Antenna cover is properly installed.
- (5) Try with another Antenna cover.
- (6) Try with another Main Board if necessary.
- (7) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.



5 - C . IrDA Connection not possible

- (1) Make sure the IrDA port settings on the Notebook or PC are properly set.
- (2) Make sure the IrDA function is properly activated on the Pocket PC and on the other device.
- (3) Make sure there's no obstruction between the two devices in connection and within the distance.
- (4) Check the IrDA window whether it is broken or cracked. Replace Front Bezel if necessary.
- (5) Replace Main Board if necessary.
- (6) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.

6 - A . Main Battery does not start

- (1) Make sure the Battery cover is closed properly.
- (2) Connect to the AC Adapter and see if it takes charge. Also check AC Adapter condition.
- (3) Check whether AC Adapter is functioning properly.
- (4) Check whether the condition of Battery Charging status is correct.
- (5) Dismantle the unit and check the appearance of Battery cover.
- (6) Try with another Main Board or Replace Main Board if necessary.
- (7) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.

6 - B . Battery discharges quickly even after fully charged

- (1) Make sure the Battery Pack takes fully charge with AC Adapter.
- (2) Check whether the condition of Battery Charging status is correct.
- (3) Dismantle the unit and check the appearance of Battery cover.
- (4) Try with another Battery or Replace Battery if necessary
- (5) Try with another Main Board or Replace Main Board if necessary.
- (6) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.



7 - C . Main Battery does not recharge

- (1) Make sure the Battery takes fully charge with AC Adapter.
- (2) Check whether the condition of Battery Charging status is correct. Charge should be done in no more than 3 hours.
- (3) Dismantle the unit and check the appearance of Battery cover.
- (4) Try with another Battery or Replace Battery if necessary
- (5) Try with another Main Board or Replace Main Board if necessary.
- (6) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.

8 - A . No Sound from Speaker or Distorted sound

- (1) Check "Sound & Notifications" Settings in the unit for Sound Enabling.
- (2) Make sure it's not MUTED.
- (3) Dismantle and Check whether the Speaker is properly installed (Orientation)
- (4) Make sure the connection point between MB and Speaker is free from contamination or dust.
- (5) Replace Speaker if necessary.
- (6) Replace Main Board if necessary.
- (7) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.
- (8) Replace Camera if camera function was defect at the same time.

9 - A . No Recorded Sound or Distorted sound

- (1) Check "Sound & Notifications" Settings in the unit for Sound Enabling.
- (2) Make sure it's not MUTED.
- (3) Dismantle and Check whether the Microphone is properly installed (check or missing rubber)
- (4) Replace Microphone if necessary.
- (5) Replace Main Board if necessary.
- (6) Once the defective part has been identified, verify it again with the defective part whether the symptom could be duplicated.

10 - A . Bezel, Housing Cosmetic damage

(1) Unless it is for Refurbishment, all Bezel, housing replacement due to cosmetic damage shall treat as out of warranty



CHAPTER 9 – GENERIC SPARE PART LIST

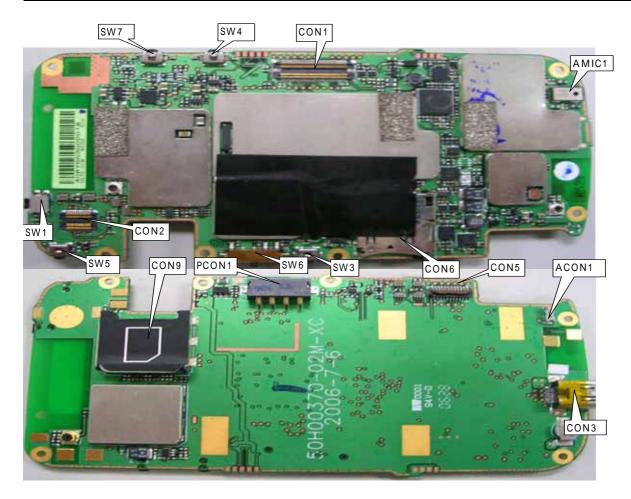
9.1 SPL for Repair

| ltem | HTC P/N | Description | Using Q'ty |
|------|--------------|--|---------------|
| 1 | 36H00468-00M | Receiver, MERRY, DTR882-001 | 1 |
| 2 | 36H00486-00M | Speaker,MERRY,DSH962-002 | 1 |
| 3 | 36H00488-00M | Wifi-Edge Antenna Pre-Assy -W/O Elec Inspection,AMPHENOL,H | 1 |
| 4 | 36H00490-00M | Vibrator,JT05508-30NC1,JNTECH,Reted speed 125003000 RPN | 1 |
| 5 | 51H00370-01M | PCBA-MAIN BOARD,Herald | 1 |
| 6 | 51H10048-00M | Rigid-Flex Board ASSY,5Layers,HERALD | 1 |
| 7 | 54H00188-00M | Module Assy, Camera, PRIMAX, 50-70407HTT0; Sensor: Samsung | 1 |
| 8 | 60H00062-00M | LCD Module,ACX357AKM-8,SONY,73.7*52.9*3.3mm | 1 |
| 9 | 72H01691-00M | Screw,M1-6,L3-5,T5(2.8*0.7),Black,Herald | 4 |
| 10 | 72H01696-00M | Screw,M1.4,L2-0(3.5*0.2),Cross,Herald | 6 |
| 11 | 72H01701-00M | Screw,M1.6,L2.0(2.7*0.5),T5,Herald | 6 |
| 12 | 72H01706-00M | Screw,M1-6,L2-8,T5,Herald | 4 |
| 13 | 72H01712-00M | EMI Gasket, RF board, Herald | 2 |
| 14 | 72H01715-00M | Screw,HAMA NAKA SHOUKIN,T1.6,DELTA TP | 5 |
| 15 | 72H01787-00M | EMI Gasket,for SONY LCM,Herald | 1 |
| 16 | 73H20074-09M | FPC Pre-Assy,QWERTY KEY,CAREER,Herald | 1 |
| 17 | 74H00755-00M | Bezel Pre-Assy,keyboard upper cover assy,Herald | 1 |
| 18 | 74H00756-00M | Slider-Hinge Pre-Assy,Semi-Auto,Herald | 1 |
| 19 | 74H00758-XXM | Keypad Pre-Assy,Qwerty key,Generic WWE,Herald | 1 |
| 20 | 74H00759-00M | Bezel Pre-Assy, Display, Bottom Cover, Herald | 1 |
| 21 | 74H00760-00M | Cover Pre-Assy, Battery, Herald | 1 |
| 22 | 74H00763-00M | Housing Pre-Assy,keyboard bottom cover assy,Herald | 1 |
| 23 | 74H00764-00M | Keypad Pre-Assy,AP function key,Herald | 1 |
| 24 | 74H00767-02M | Bezel Pre-Assy,display upper cover assy,Herald | 1 |
| 25 | 76H01586-00M | Rubber, Silicone, Rf Conn., Herald | 1 |
| 26 | 76H01587-00M | Film,Label,SIM connector,Herald | 1 |
| 27 | 76H01590-00M | Rubber, Silicone, Microphone, Herald | 1 |
| 28 | 76H01593-00M | Absorber,CA20,Camera FPC,Herald | 1 |
| 29 | 76H01594-00M | Mylar,749B,on PCBA,Herald | 2 |
| 30 | 76H01597-00M | Mylar,anti-short,on RFBD,749B,Herald | 1 |
| 31 | 76H01600-00M | Tape,KAPTON,on B2B conn RFBD,Herald | 1 |
| 32 | 76H01651-00M | Tape, Kapton, Qwerty FPC conn, Herald | 1 |
| 33 | 77H00116-02M | LCD Film for EULA, PDA, 85*55mm, ENG/CHT/CHS, Himalayas | 1 |
| 34 | 77H00203-00M | Water Sensitive Label, 4*2.5mm, Ming Jye, BlueAngels | 1 |
| 35 | 77H00385-10M | Regulation Label, DOPOD-ASIA, 41.8*62.1mm, CHENG MAY, Hera | 1 |
| 36 | 77H00460-XXM | Tamper-Evident Label, VOID wording, black background, 3*3mm, M | 1 |
| 37 | 77H30025-00M | BLANK LABEL,48*93mm | 2 |



9.2 Board Level

| Item | HTC P/N | Description | Using Q'ty | Location | Remark |
|------|--------------|--|---------------|-----------|---------------------------------|
| 1 | 36H00129-00M | SWITCH BUTTON,PTS-106,HCH,4.7*4.5*1.65,70/-20degC,BLUE ANGELS | 1 | (SW1) | Power |
| 2 | 36H00160-00M | Slide_Switch,HSS112,HCH | 1 | (SW6) | Slide_Switch |
| 3 | 36H00208-00M | MIC,SP0103NB3-SB-3,EMKAY,Pb-FREE,100/-40degC,6.15*3.76*1.45 mm | 1 | (AMIC1) | Mic |
| 4 | 36H00230-00M | SWITCH,SOH-213HST,MITSUMI,70/-20degC | 3 | (SW4,5,7) | Voice command, Capture, COMM |
| 5 | 36H00308-00M | Switch,Reset switch,SOH-213HNT,MITSUMI | 1 | (SW3) | Reset |
| 6 | 75H00420-00M | Connector B to B,Female,22P,0.4Pitch,AXK7L22227,MATSUSHITA,6.8*5.0*0.87mm | 1 | (CON2) | Main Camera Module |
| 7 | 75H00554-00M | Connector,4Pin,2.5mm,250037MB004G511ZL-C,SUYIN,40mohm,2A,12V | 1 | (PCON1) | Battery connector |
| 8 | 75H00465-00M | Connector I/O,Reverse,11P,0.4Pitch,MJE21-11K7P20,ACON | 1 | (CON3) | Mini USB |
| 9 | 75H00467-11M | Connector SD Card,10P,1.1Pitch,100053FB010S402ZL,SUYIN,100mohm,0.5A,5V | 1 | (CON6) | Micro SD Card |
| 10 | 75H00565-00M | Connector SIM Card,8P,2.54Pitch,HAMBURG,ICC-439,Herald | 1 | (CON9) | Connector SIM Card |
| 11 | 75H00566-00M | Connector B to C,2P,1Pitch,1A,30V,KYOCERA,248000002000829+,Herald | 1 | (ACON1) | ∨ibratorr connector |
| 12 | 75H00578-00P | Connector B to B,60P,0.4Pitch,24 5801 060 003 829,KYOCERA | 1 | (CON1) | LCM |
| 13 | 75H00579-00M | Connector FPC,23P,0.3Pitch,FH26-23S-0.3SHW(05),HIROSE | 1 | (CON5) | Keypad |





APPENDIX

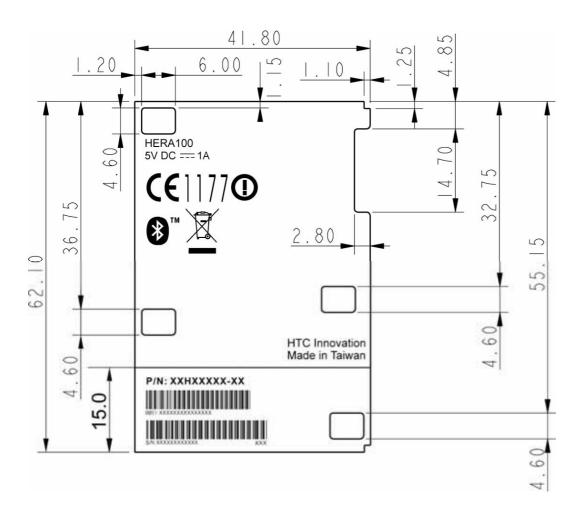
A. Generic Labeling Plan

A1 Agency label-W/WiFi

HTC P/N: 77H00385-00M

Size: 41.8 X 62.1mm

The brand name is shown on Bezel.



| HTC P/N | Countries supported |
|---------|---------------------|
| | |

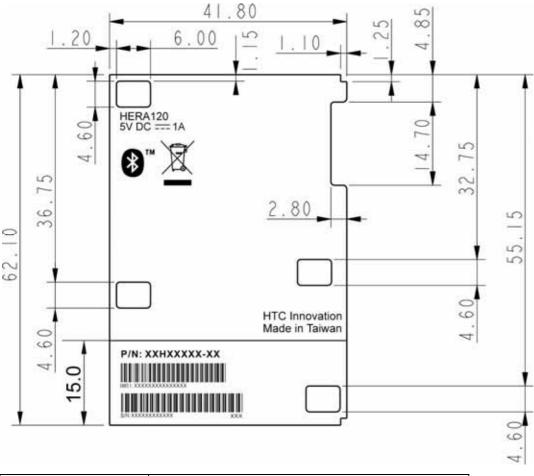


A2 Agency label-W/O WiFi

HTC P/N: 77H00385-04M

Size: 41.8 X 62.1mm

The brand name is shown on Bezel.



| HTC P/N | Countries supported |
|---------|---------------------|
| | |



B. RF Antenna Test Specification

| Item | Test Name | Tx level | тсн | 1 st Download cell power | Note | |
|---------------------------|---------------------|-----------|------------|--|---------|--|
| 1 | Camp @DCS Band | 0 | 512 | -75 | BCH=600 | |
| 2 | BS Originate call | 0 | 512 | -75 | | |
| | | E-GSM 900 | RECEIV | ER TEST | | |
| 3 | Fast Bit Error Rate | 5 | 975 | -104 | | |
| 4 | Fast Bit Error Rate | 5 | 42 | -104 | | |
| 5 | Fast Bit Error Rate | 5 | 124 | -104 | | |
| | I | E-GSM 900 | Transmi | tter TEST | | |
| 6 | TX Phase RMS Error | 5 | 975 | -104 | | |
| 7 | TX Phase Peak Error | 5 | 975 | -104 | | |
| 8 | TX Frequency Error | 5 | 975 | -104 | | |
| 9 | TX Phase RMS Error | 5 | 42 | -104 | | |
| 10 | TX Phase Peak Error | 5 | 42 | -104 | | |
| 11 | TX Frequency Error | 5 | 42 | -104 | | |
| 12 | TX Phase RMS Error | 5 | 124 | -104 | | |
| 13 | TX Phase Peak Error | 5 | 124 | -104 | | |
| 14 | TX Frequency Error | 5 | 124 | -104 | | |
| 15 | Check TX Power | 5 | 975 | -104 | | |
| 16 | Check TX Power | 5 | 42 | -104 | | |
| 17 | Check TX Power | 5 | 124 | -104 | | |
| | | DCS 180 | 00 Receive | er Test | | |
| 1 F | ast Bit Error Rate | 0 | 512 | -104 | | |
| | ast Bit Error Rate | 0 | 698 | -104 | | |
| 3 F | ast Bit Error Rate | 0 | 885 | -104 | | |
| DCS 1800 Transmitter Test | | | | | | |
| 4 | TX Phase RMS Error | 0 | 512 | -104 | | |
| 5 | TX Phase Peak Error | 0 | 512 | -104 | | |
| 6 | TX Frequency Error | 0 | 512 | -104 | | |
| 7 | TX Phase RMS Error | 0 | 698 | -104 | | |

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| | | | 1 | | | |
|----------------------------------|--------------------------|----------|-----------|----------|--|--|
| 8 | TX Phase Peak Error | 0 | 698 | -104 | | |
| 9 | TX Frequency Error | 0 | 698 | -104 | | |
| 10 | TX Phase RMS Error | 0 | 885 | -104 | | |
| 11 | TX Phase Peak Error | 0 | 885 | -104 | | |
| 12 | TX Frequency Error | 0 | 885 | -104 | | |
| 13 | Check TX Power | 0 | 512 | -104 | | |
| 14 | Check TX Power | 0 | 698 | -104 | | |
| 15 | Check TX Power | 0 | 885 | -104 | | |
| | | PCS 190 | 0 Receive | er Test | | |
| 1 | Fast Bit Error Rate | 0 | 512 | -104 | | |
| 2 | Fast Bit Error Rate | 0 | 661 | -104 | | |
| 3 | Fast Bit Error Rate | 0 | 810 | -104 | | |
| | | PCS 1900 | Transmit | ter Test | | |
| 4 | TX Phase RMS Error | 0 | 512 | -104 | | |
| 5 | TX Phase Peak Error | 0 | 512 | -104 | | |
| 6 | TX Frequency Error | 0 | 512 | -104 | | |
| 7 | TX Phase RMS Error | 0 | 661 | -104 | | |
| 8 | TX Phase Peak Error | 0 | 661 | -104 | | |
| 9 | TX Frequency Error | 0 | 660 | -104 | | |
| 10 | TX Phase RMS Error | 0 | 810 | -104 | | |
| 11 | TX Phase Peak Error | 0 | 810 | -104 | | |
| 12 | TX Frequency Error | 0 | 810 | -104 | | |
| 13 | Check TX Power | 0 | 512 | -104 | | |
| 14 | Check TX Power | 0 | 661 | -104 | | |
| 15 | Check TX Power | 0 | 810 | -104 | | |
| GSM 850 Receiver Test | | | | | | |
| 1 | Fast Bit Error Rate | 5 | 128 | -104 | | |
| 2 | Fast Bit Error Rate | 5 | 189 | -104 | | |
| 3 Fast Bit Error Rate 5 251 -104 | | | | | | |
| | GSM 850 Transmitter Test | | | | | |
| 4 | TX Phase RMS Error | 5 | 128 | -104 | | |



| 5 | TX Phase Peak Error | 5 | 128 | -104 | |
|----|---------------------|---|-----|------|--|
| 6 | TX Frequency Error | 5 | 128 | -104 | |
| 7 | TX Phase RMS Error | 5 | 189 | -104 | |
| 8 | TX Phase Peak Error | 5 | 189 | -104 | |
| 9 | TX Frequency Error | 5 | 189 | -104 | |
| 10 | TX Phase RMS Error | 5 | 251 | -104 | |
| 11 | TX Phase Peak Error | 5 | 251 | -104 | |
| 12 | TX Frequency Error | 5 | 251 | -104 | |
| 13 | Check TX Power | 5 | 128 | -104 | |
| 14 | Check TX Power | 5 | 189 | -104 | |
| 15 | Check TX Power | 5 | 251 | -104 | |



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